

## PATENT ASSIGNMENT COVER SHEET

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EPAS ID: PAT3359182

<b>SUBMISSION TYPE:</b>	NEW ASSIGNMENT
<b>NATURE OF CONVEYANCE:</b>	ASSIGNMENT
<b>CONVEYING PARTY DATA</b>	
<b>Name</b>	<b>Execution Date</b>
SUNGWAN KIM	05/13/2015
YODAN KIM	05/13/2015
HYEONHOE KIM	05/13/2015
HEE CHAN KIM	05/13/2015
CHAN GOOK PARK	05/12/2015
CHOONGHEE LEE	05/13/2015
CHIWON LEE	05/13/2015
YONG HYUN PARK	05/12/2015
SEUNGWOO NOH	05/13/2015
CHIYUL YOON	05/13/2015
<b>RECEIVING PARTY DATA</b>	
<b>Name:</b>	SNU R&DB FOUNDATION
<b>Street Address:</b>	SAN 56-1, SHILLIM-DONG, GWANAK-GU
<b>City:</b>	SEOUL
<b>State/Country:</b>	KOREA, REPUBLIC OF
<b>PROPERTY NUMBERS Total: 1</b>	
<b>Property Type</b>	<b>Number</b>
Application Number:	14714800
<b>CORRESPONDENCE DATA</b>	
<b>Fax Number:</b>	
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
<b>Phone:</b>	6124553800
<b>Email:</b>	ykase@hsm1.com
<b>Correspondent Name:</b>	HAMRE, SCHUMANN, MUELLER & LARSON, P.C.
<b>Address Line 1:</b>	P.O. BOX 2902
<b>Address Line 4:</b>	MINNEAPOLIS, MINNESOTA 55402
<b>ATTORNEY DOCKET NUMBER:</b>	12109.1028US11
<b>NAME OF SUBMITTER:</b>	CURTIS B. HAMRE

<b>SIGNATURE:</b>	/Curtis B. Hamre/
<b>DATE SIGNED:</b>	05/19/2015
<b>Total Attachments: 9</b> source=Assignment_1028#page1.tif source=Assignment_1028#page2.tif source=Assignment_1028#page3.tif source=Assignment_1028#page4.tif source=Assignment_1028#page5.tif source=Assignment_1028#page6.tif source=Assignment_1028#page7.tif source=Assignment_1028#page8.tif source=Assignment_1028#page9.tif	

Docket No. 12109.1028US11

**ASSIGNMENT OF PATENT APPLICATION**

WHEREAS,

1. **Sungwan KIM**, having an address of 313, 11F, Dept. of Biomedical Engineering, Seoul Nat'l Univ. Hosp., 101, Dachak-ro, Jongno-gu, Seoul, 110-744 Republic of Korea;
2. **Youdan KIM**, having an address of 107-301, Raemian Bangbae ArtHill Apt., 1008-2, Bangbae 3-dong, Seocho-gu, Seoul 137-936, Republic of Korea;
3. **Hyeonhoe KIM** having an address of 1801, Cheonggu Apt., Cheongdam-dong, Gangnam-gu, Seoul 135-100, Republic of Korea;
4. **Hee Chan KIM** having an address of 515-701, Bukhansan I'Park Apt., 825, Chang 5-dong, Dobong-gu, Seoul 132-738, Republic of Korea;
5. **Chan Gook PARK** having an address of 201-1501, Family Apt., 150, Moonjung 2-dong, Songpa-gu, Seoul 138-768, Republic of Korea;
6. **Choonghee LEE** having an address of 46-44, Myeonmok 8-dong, Jungnang-gu, Seoul 131-200, Republic of Korea;
7. **Chiwon LEE** having an address of 815-102, Cheongseok Maeul Dongmun, Goodmorning Hill Apt., Dayul-dong, Paju-si, Gyeonggi-do 413-783, Republic of Korea;
8. **Yong Hyun PARK** having an address of 5-601, Jinju Apt., Jamsil 4-dong, Songpa-gu, Seoul 138-795, Republic of Korea;
9. **Seungwoo NOH** having an address of 115-603, Hyundai Apt., Dadae 2-dong, Saha-gu, Busan 604-756, Republic of Korea; and
10. **Chiyul YOON** having an address of 778-15, Mok 4-dong, Yangcheon-gu, Seoul 158-818, Republic of Korea

(hereinafter called "THE UNDERSIGNED") have made an invention and have executed an application for Letters Patent of the United States for this invention which was filed on \_\_\_\_\_, entitled **SURGICAL ROBOT CONTROL APPARATUS**, and which has been given application serial number \_\_\_\_\_;

and

WHEREAS **SNU R&DB FOUNDATION** (hereinafter "ASSIGNEE") a corporation organized under the laws of Republic of Korea and having an office and place of business at San 56-1, Shillim-dong, Gwanak-gu, Seoul 151-742, Republic of Korea wishes to

acquire the entire right, title and interest in and to said invention and patent application and any Letters Patent to be obtained therefor;

NOW, THEREFORE, for and in consideration of the sum of One Dollar (\$1.00) and other good and valuable consideration, the receipt and sufficiency of which is hereby acknowledged, THE UNDERSIGNED hereby sell, assign, and transfer to the ASSIGNEE, its successors, legal representative and assigns, the entire right, title and interest for the United States in and to the invention disclosed in said application, and in and to said application, as well as to all divisions, continuations, or renewals thereof, all Letters Patent which may be granted therefrom, and all reissues or extensions of such patents, and THE UNDERSIGNED hereby authorize and request the Commissioner of Patents of the United States to issue all Letters Patent for said invention to the ASSIGNEE of the entire right, title and interest in and to the same, in accordance with the terms of this instrument.

THE UNDERSIGNED hereby agree that THE UNDERSIGNED, their executors and legal representatives will make, execute and deliver (without charge but at the expense of the ASSIGNEE) any and all other instruments in writing including any and all further application papers, affidavits, assignments and other documents, and will communicate to said ASSIGNEE, its successors and representatives all facts known to the UNDERSIGNED relating to said invention and the history thereof and will testify in all legal proceedings and generally do all things which may be necessary or desirable to vest the ASSIGNEE, its successors or assigns, the entire right, title and interest in and to the said invention, patent applications, Letters Patent, rights, titles, benefits, privileges, and advantages hereby sold, assigned and conveyed, or intended so to be.

THE UNDERSIGNED represent and agree with said ASSIGNEE, its successors and assigns, that no assignment, grant, mortgage, license or other agreement affecting the rights and property herein conveyed has been or will be made to others by the UNDERSIGNED, and that full right to convey the same as herein expressed is possessed by the UNDERSIGNED.

IN TESTIMONY WHEREOF, THE UNDERSIGNED have hereunto set their hand on the dates indicated below.

  
1. Sungwan KIM

5-13-2015  
Date

  
2. Youdan KIM

May 13, 2015  
Date

Yeonhoe Kim  
3. Hyeonhoe KIM

May/13/2015  
Date

Hee Chan Kim  
4. Hee Chan KIM

May 13, 2015  
Date

\_\_\_\_\_  
5. Chan Gook PARK

\_\_\_\_\_  
Date

\_\_\_\_\_  
6. Choonghee LEE

\_\_\_\_\_  
Date

\_\_\_\_\_  
7. Chiwon LEE

\_\_\_\_\_  
Date

\_\_\_\_\_  
8. Yong Hyun PARK

\_\_\_\_\_  
Date

\_\_\_\_\_  
9. Seungwoo NOH

\_\_\_\_\_  
Date

\_\_\_\_\_  
10. Chiyul YOON

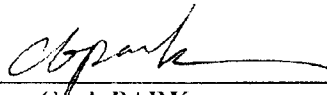
\_\_\_\_\_  
Date

3. Hyeonhoe KIM

Date

4. Hee Chan KIM

Date

  
5. Chan Gook PARK

May 12, 2015  
Date

6. Choonghee LEE

Date

7. Chiwon LEE

Date

8. Yong Hyun PARK

Date

9. Seungwoo NOH

Date

10. Chiyul YOON

Date

3. Hyeonhoe KIM

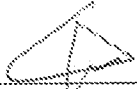
Date

4. Hee Chan KIM

Date

5. Chan Gook PARK

Date



6. Choonghee LEE

Date

May 13, 2015

7. Chiwon LEE

Date

8. Yong Hyun PARK

Date

9. Seungwoo NOH

Date

10. Chiyul YOON

Date

3. Hyeonhoe KIM

Date

4. Hee Chan KIM

Date

5. Chan Gook PARK

Date

6. Choonghee LEE

Date

0/2/12  
7. Chiwon LEE

MAY 13, 2015  
Date

8. Yong Hyun PARK

Date

9. Seungwoo NOH

Date

10. Chiyul YOON

Date



3. Hyeonhoe KIM

Date

4. Hee Chan KIM

Date

5. Chan Gook PARK

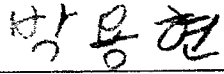
Date

6. Choonghee LEE

Date

7. Chiwon LEE

Date

  
8. Yong Hyun PARK

*May 12, 2015*  
Date

9. Seungwoo NOH

Date

10. Chiyul YOON

Date

3. Hyeonhoe KIM

Date

4. Hee Chan KIM

Date

5. Chan Gook PARK

Date

6. Choonghee LEE

Date

7. Chiwon LEE

Date

8. Yong Hyun PARK

Date

*Seungwoo noh*  
9. Seungwoo NOH

*May 13, 2015*  
Date

10. Chiyul YOON

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3. Hyeonhoe KIM

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4. Hee Chan KIM

Date

5. Chan Gook PARK

Date

6. Choonghee LEE

Date

7. Chiwon LEE

Date

8. Yong Hyun PARK

Date

9. Seungwoo NOH

Date

*Chiyul Yoon*  
10. Chiyul YOON

*2015/05/13*  
Date